

## Ratiometric Linear Hall Effect Sensor for High-Temperature Operation

### Features and Benefits

- Temperature-stable quiescent output voltage
- Precise recoverability after temperature cycling
- Output voltage proportional to magnetic flux density
- Ratiometric rail-to-rail output
- Improved sensitivity
- 4.5 to 5.5 V operation
- Immunity to mechanical stress
- Solid-state reliability
- Robust EMC protection

**Packages: 3 pin SOT23W (suffix LH), and 3 pin SIP (suffix UA)**



*Not to scale*

### Description

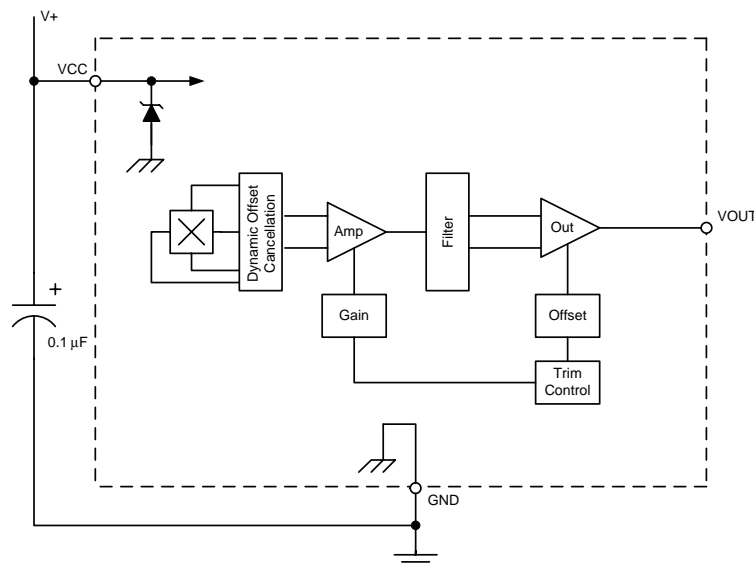
The A132X family of linear Hall-effect sensors are optimized, sensitive, and temperature-stable. These ratiometric Hall-effect sensors provide a voltage output that is proportional to the applied magnetic field. The A132X family has a quiescent output voltage that is 50% of the supply voltage and output sensitivity options of 2.5mV/G, 3.125mV/G, and 5mV/G. The features of this family of devices are ideal for use in the harsh environments found in automotive and industrial linear and rotary position sensing systems.

Each device has a BiCMOS monolithic circuit which integrates a Hall element, improved temperature-compensating circuitry to reduce the intrinsic sensitivity drift of the Hall element, a small-signal high-gain amplifier, and a rail-to-rail low-impedance output stage.

A proprietary dynamic offset cancellation technique, with an internal high-frequency clock, reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress. The high frequency clock allows for a greater sampling rate, which results in higher accuracy and faster signal processing capability. This technique produces devices that have an extremely stable quiescent output voltage, are immune to mechanical stress, and have precise

*Continued on the next page...*

### Functional Block Diagram



# A1321, A1322, and A1323

# Ratiometric Linear Hall Effect Sensor for High-Temperature Operation

## Description (continued)

recoverability after temperature cycling. Having the Hall element and an amplifier on a single chip minimizes many problems normally associated with low-level analog signals.

Output precision is obtained by internal gain and offset trim adjustments made at end-of-line during the manufacturing process.

The A132X family is provided in a 3-pin single in-line package (UA) and a 3-pin surface mount package (LH). Each package is available in a lead (Pb) free version (suffix, -T), with a 100% matte tin plated leadframe.

## Selection Guide

| Part Number  | Pb-free <sup>1</sup> | Packing <sup>2</sup>         | Mounting         | Ambient, T <sub>A</sub><br>(°C) | Sensitivity,<br>Typ. (mV/G) |
|--------------|----------------------|------------------------------|------------------|---------------------------------|-----------------------------|
| A1321ELHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 85                       | 5.000                       |
| A1321EUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |
| A1321LLHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 150                      |                             |
| A1321LUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |
| A1322ELHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 85                       | 3.125                       |
| A1322EUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |
| A1322LLHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 150                      |                             |
| A1322LUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |
| A1323ELHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 85                       | 2.500                       |
| A1323EUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |
| A1323LLHLT-T | Yes                  | 7-in. reel, 3000 pieces/reel | Surface Mount    | -40 to 150                      |                             |
| A1323LUA-T   | Yes                  | Bulk, 500 pieces/bag         | SIP through hole |                                 |                             |

<sup>1</sup>Pb-based variants are being phased out of the product line.

a. Certain variants cited in this footnote are in production but have been determined to be LAST TIME BUY. This classification indicates that sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because obsolescence in the near future is probable. Samples are no longer available. Status change: October 31, 2006. Deadline for receipt of LAST TIME BUY ORDERS: April 27, 2007. These variants include: A1322ELHLT, A1322EUA, and A1323LLHLT.

b. Certain variants cited in this footnote are in production but have been determined to be NOT FOR NEW DESIGN. This classification indicates that sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because obsolescence in the near future is probable. Samples are no longer available. Status change: May 1, 2006. These variants include: A1321ELHLT, A1321EUA, A1321LLHLT, A1321LUA, A1322LLHLT, A1322LUA, A1323ELHLT, A1323EUA, and A1323LUA.

<sup>2</sup>Contact Allegro for additional packing options.



## Absolute Maximum Ratings

| Characteristic                | Symbol              | Notes   | Rating     | Units |
|-------------------------------|---------------------|---|------------|-------|
| Supply Voltage                | V <sub>CC</sub>     | *Additional current draw may be observed at voltages above the minimum supply Zener clamp voltage, V <sub>Z(min)</sub> , due to the Zener diode turning on. | 8          | V     |
| Output Voltage                | V <sub>OUT</sub>    |   | 8          | V     |
| Reverse Supply Voltage        | V <sub>RCC</sub>    |   | -0.1       | V     |
| Reverse Supply Voltage        | V <sub>RCC</sub>    |   | -0.1       | V     |
| Output Sink Current           | I <sub>OUT</sub>    |   | 10         | mA    |
| Operating Ambient Temperature | T <sub>A</sub>      | Range E   | -40 to 85  | °C    |
|                               |                     | Range L   | -40 to 150 | °C    |
| Maximum Junction Temperature  | T <sub>J(max)</sub> |   | 165        | °C    |
| Storage Temperature           | T <sub>stg</sub>    |   | -65 to 170 | °C    |

DEVICE CHARACTERISTICS<sup>1</sup> over operating temperature ( $T_A$ ) range, unless otherwise noted

| Characteristic  | Symbol        | Test Conditions  | Min.  | Typ. <sup>2</sup> | Max.  | Units      |
|---|---------------|--|-------|-------------------|-------|------------|
| <b>Electrical Characteristics;</b> $V_{CC} = 5\text{ V}$ , unless otherwise noted |               |  |       |                   |       |            |
| Supply Voltage  | $V_{CC(OP)}$  | Operating; $T_j < 165^\circ\text{C}$                   | 4.5   | 5.0               | 5.5   | V          |
| Supply Current  | $I_{CC}$      | $B = 0, I_{out} = 0$                                   | –     | 5.6               | 8     | mA         |
| Quiescent Voltage   | $V_{out(Q)}$  | $B = 0, T_A = 25^\circ\text{C}, I_{out} = 1\text{ mA}$ | 2.425 | 2.5               | 2.575 | V          |
| Output Voltage <sup>3</sup>   | $V_{out(H)}$  | $B = +X, I_{out} = -1\text{ mA}$                       | –     | 4.7               | –     | V          |
|   | $V_{out(L)}$  | $B = -X, I_{out} = 1\text{ mA}$                        | –     | 0.2               | –     | V          |
| Output Source Current Limit <sup>3</sup>  | $I_{out(LM)}$ | $B = -X, V_{out} \rightarrow 0$                        | -1.0  | -1.5              | –     | mA         |
| Supply Zener Clamp Voltage  | $V_Z$         | $I_{CC} = 11\text{ mA} = I_{CC(max)} + 3$              | 6     | 8.3               | –     | V          |
| Output Bandwidth  | BW            |  | –     | 30                | –     | kHz        |
| Clock Frequency   | $f_C$         |  | –     | 150               | –     | kHz        |
| <b>Output Characteristics;</b> over $V_{CC}$ range, unless otherwise noted        |               |  |       |                   |       |            |
| Noise, Peak-to-Peak <sup>4</sup>  | $V_N$         | A1321; $C_{bypass} = 0.1\text{ }\mu\text{F}$ , no load | –     | –                 | 40    | mV         |
|   |               | A1322; $C_{bypass} = 0.1\text{ }\mu\text{F}$ , no load | –     | –                 | 25    | mV         |
|   |               | A1323; $C_{bypass} = 0.1\text{ }\mu\text{F}$ , no load | –     | –                 | 20    | mV         |
| Output Resistance   | $R_{out}$     | $I_{out} \leq \pm 1\text{ mA}$                         | –     | 1.5               | 3     | $\Omega$   |
| Output Load Resistance  | $R_L$         | $I_{out} \leq \pm 1\text{ mA}, V_{OUT}$ to GND         | 4.7   | –                 | –     | k $\Omega$ |
| Output Load Capacitance   | $C_L$         | $V_{OUT}$ to GND                                       | –     | –                 | 10    | nF         |

<sup>1</sup> Negative current is defined as conventional current coming out of (sourced from) the specified device terminal.

<sup>2</sup> Typical data is at  $T_A = 25^\circ\text{C}$ . They are for initial design estimations only, and assume optimum manufacturing and application conditions. Performance may vary for individual units, within the specified maximum and minimum limits.

<sup>3</sup> In these tests, the vector **X** is intended to represent positive and negative fields sufficient to swing the output driver between fully OFF and saturated (ON), respectively. It is NOT intended to indicate a range of linear operation.

<sup>4</sup> Noise specification includes both digital and analog noise.

# A1321, A1322, and A1323

# Ratiometric Linear Hall Effect Sensor for High-Temperature Operation

**MAGNETIC CHARACTERISTICS**<sup>1,2</sup> over operating temperature range,  $T_A$ ;  $V_{CC} = 5\text{ V}$ ,  $I_{out} = -1\text{ mA}$ ; unless otherwise noted

| Characteristics                                 | Symbol                                  | Test Condition   | Min   | Typ <sup>3</sup> | Max       | Units <sup>4</sup> |
|---|---|--|-------|------------------|-----------|--------------------|
| Sensitivity <sup>5</sup>                        | Sens                                    | A1321; $T_A = 25^\circ\text{C}$                                    | 4.750 | 5.000            | 5.250     | mV/G               |
|   |   | A1322; $T_A = 25^\circ\text{C}$                                    | 2.969 | 3.125            | 3.281     | mV/G               |
|   |   | A1323; $T_A = 25^\circ\text{C}$                                    | 2.375 | 2.500            | 2.625     | mV/G               |
| Delta $V_{out(q)}$ as a function of temperature | $V_{out(q)(\Delta T)}$                  | Defined in terms of magnetic flux density, B                       | –     | –                | $\pm 10$  | G                  |
| Ratiometry, $V_{out(q)}$                        | $V_{out(q)(\Delta V)}$                  |  | –     | –                | $\pm 1.5$ | %                  |
| Ratiometry, Sens                                | $\Delta\text{Sens}_{(\Delta V)}$        |  | –     | –                | $\pm 1.5$ | %                  |
| Positive Linearity                              | Lin+                                    |  | –     | –                | $\pm 1.5$ | %                  |
| Negative Linearity                              | Lin–                                    |  | –     | –                | $\pm 1.5$ | %                  |
| Symmetry  | Sym                                     |  | –     | –                | $\pm 1.5$ | %                  |
| <b>UA Package</b>                               |   |  |       |                  |           |                    |
| Delta Sens at $T_A = \text{max}$ <sup>5</sup>   | $\Delta\text{Sens}_{(T_{A\text{max}})}$ | From hot to room temperature                                       | –2.5  | –                | 7.5       | %                  |
| Delta Sens at $T_A = \text{min}$ <sup>5</sup>   | $\Delta\text{Sens}_{(T_{A\text{min}})}$ | From cold to room temperature                                      | –6    | –                | 4         | %                  |
| Sensitivity Drift <sup>6</sup>                  | $\text{Sens}_{\text{Drift}}$            | $T_A = 25^\circ\text{C}$ ; after temperature cycling and over time | –     | 1                | 2         | %                  |
| <b>LH Package</b>                               |   |  |       |                  |           |                    |
| Delta Sens at $T_A = \text{max}$ <sup>5</sup>   | $\Delta\text{Sens}_{(T_{A\text{max}})}$ | From hot to room temperature                                       | –5    | –                | 5         | %                  |
| Delta Sens at $T_A = \text{min}$ <sup>5</sup>   | $\Delta\text{Sens}_{(T_{A\text{min}})}$ | From cold to room temperature                                      | –3.5  | –                | 8.5       | %                  |
| Sensitivity Drift <sup>6</sup>                  | $\text{Sens}_{\text{Drift}}$            | $T_A = 25^\circ\text{C}$ ; after temperature cycling and over time | –     | 0.328            | 2         | %                  |

<sup>1</sup> Additional information on characteristics is provided in the section Characteristics Definitions, on the next page.

<sup>2</sup> Negative current is defined as conventional current coming out of (sourced from) the specified device terminal.

<sup>3</sup> Typical data is at  $T_A = 25^\circ\text{C}$ , except for  $\Delta\text{Sens}$ , and at x.x Sens. Typical data are for initial design estimations only, and assume optimum manufacturing and application conditions. Performance may vary for individual units, within the specified maximum and minimum limits. In addition, the typical values vary with gain.

<sup>4</sup> 10 G = 1 millitesla.

<sup>5</sup> After 150°C pre-bake and factory programming.

<sup>6</sup> Sensitivity drift is the amount of recovery with time.

**Characteristic Definitions**

**Quiescent Voltage Output.** In the quiescent state (no magnetic field), the output equals one half of the supply voltage over the operating voltage range and the operating temperature range. Due to internal component tolerances and thermal considerations, there is a tolerance on the quiescent voltage output both as a function of supply voltage and as a function of ambient temperature. For purposes of specification, the quiescent voltage output as a function of temperature is defined in terms of magnetic flux density, B, as:

$$\Delta V_{\text{out}(q)(\Delta T)} = \frac{V_{\text{out}(q)(T_A)} - V_{\text{out}(q)(25^\circ\text{C})}}{\text{Sens}_{(25^\circ\text{C})}} \quad (1)$$

This calculation yields the device's equivalent accuracy, over the operating temperature range, in gauss (G).

**Sensitivity.** The presence of a south-pole magnetic field perpendicular to the package face (the branded surface) increases the output voltage from its quiescent value toward the supply voltage rail by an amount proportional to the magnetic field applied. Conversely, the application of a north pole will decrease the output voltage from its quiescent value. This proportionality is specified as the sensitivity of the device and is defined as:

$$\text{Sens} = \frac{V_{\text{out}(-B)} - V_{\text{out}(+B)}}{2B} \quad (2)$$

The stability of sensitivity as a function of temperature is defined as:

$$\Delta \text{Sens}_{(\Delta T)} = \frac{\text{Sens}_{(T_A)} - \text{Sens}_{(25^\circ\text{C})}}{\text{Sens}_{(25^\circ\text{C})}} \times 100\% \quad (3)$$

**Ratiometric.** The A132X family features a ratiometric output. The quiescent voltage output and sensitivity are proportional to the supply voltage (ratiometric).

The percent ratiometric change in the quiescent voltage output is defined as:

$$\Delta V_{\text{out}(q)(\Delta V)} = \frac{V_{\text{out}(q)(V_{CC})} / V_{\text{out}(q)(5V)}}{V_{CC} / 5V} \times 100\% \quad (4)$$

and the percent ratiometric change in sensitivity is defined as:

$$\Delta \text{Sens}_{(\Delta V)} = \frac{\text{Sens}_{(V_{CC})} / \text{Sens}_{(5V)}}{V_{CC} / 5V} \times 100\% \quad (5)$$

**Linearity and Symmetry.** The on-chip output stage is designed to provide a linear output with a supply voltage of 5 V. Although application of very high magnetic fields will not damage these devices, it will force the output into a non-linear region. Linearity in percent is measured and defined as:

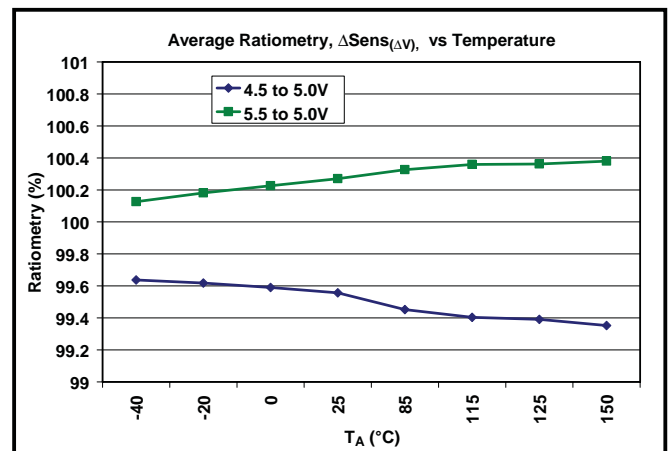
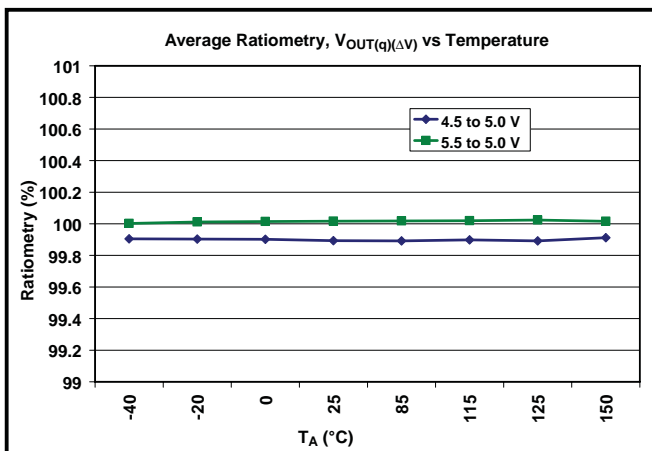
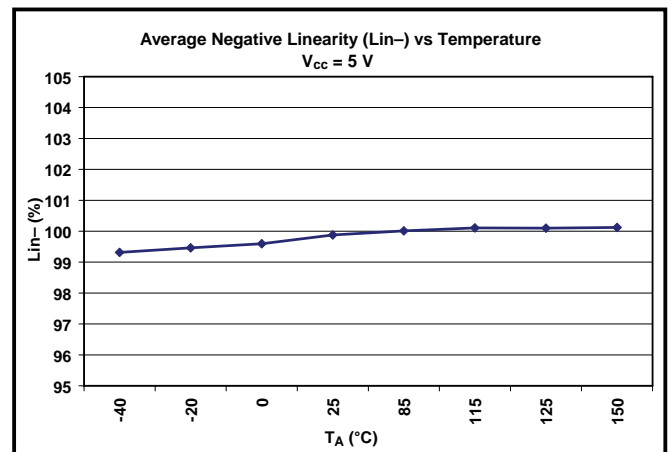
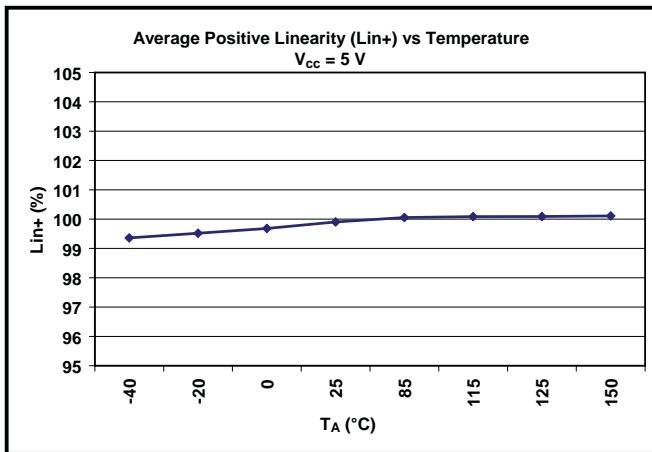
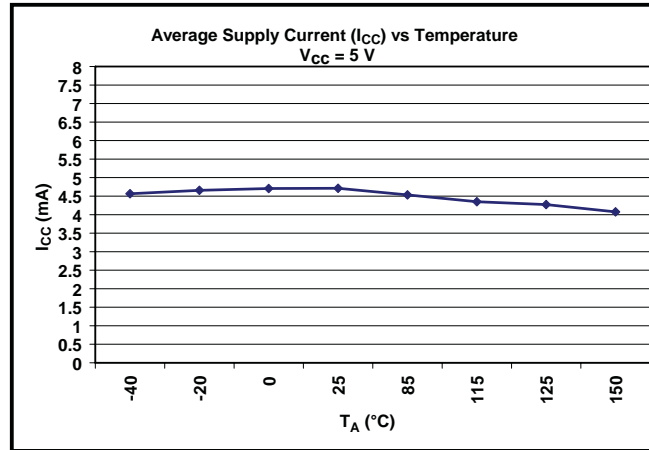
$$\text{Lin+} = \frac{V_{\text{out}(+B)} - V_{\text{out}(q)}}{2(V_{\text{out}(+B)/2} - V_{\text{out}(q)})} \times 100\% \quad (6)$$

$$\text{Lin-} = \frac{V_{\text{out}(-B)} - V_{\text{out}(q)}}{2(V_{\text{out}(-B)/2} - V_{\text{out}(q)})} \times 100\% \quad (7)$$

and output symmetry as:

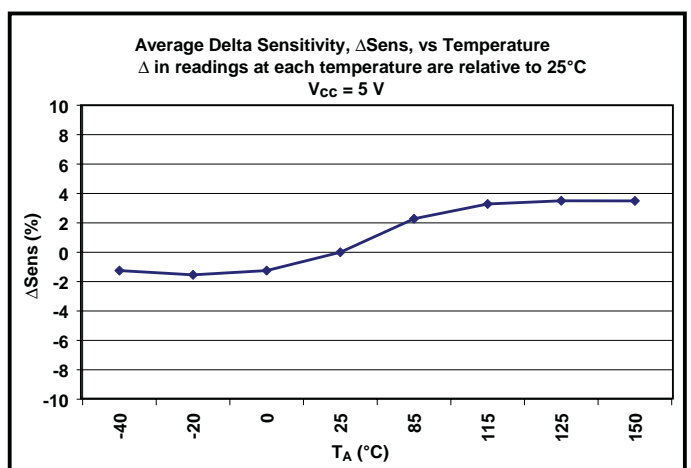
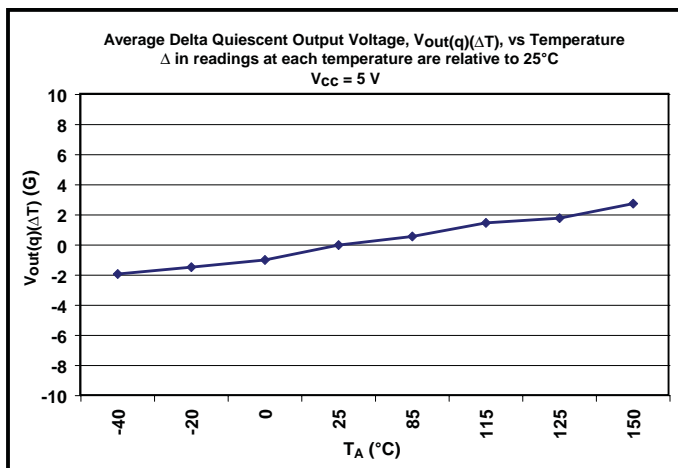
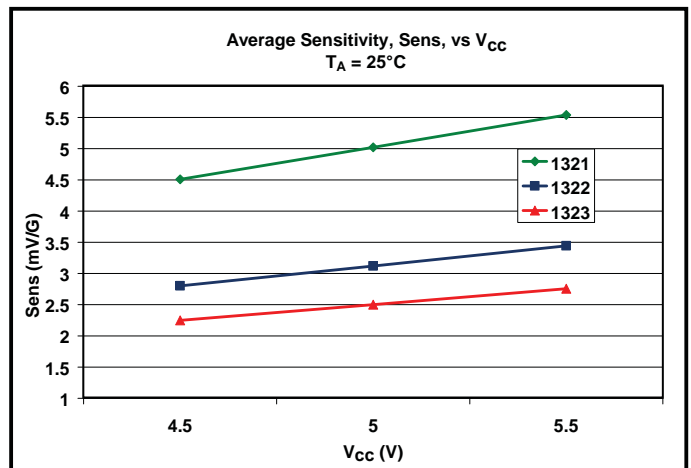
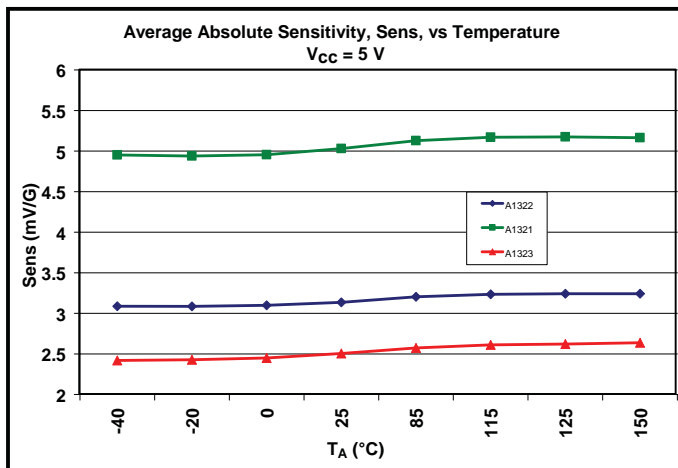
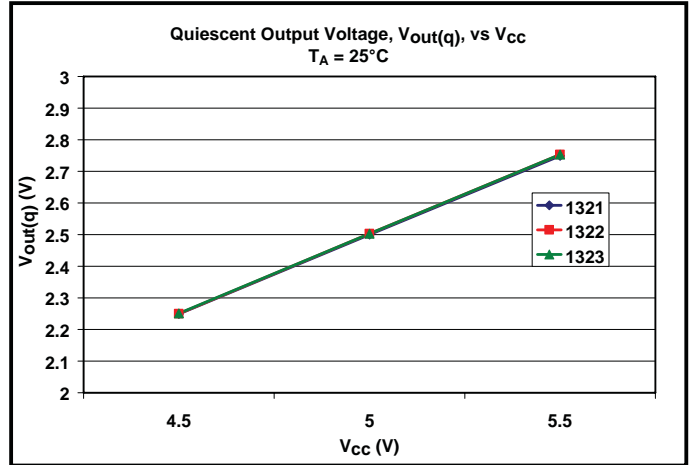
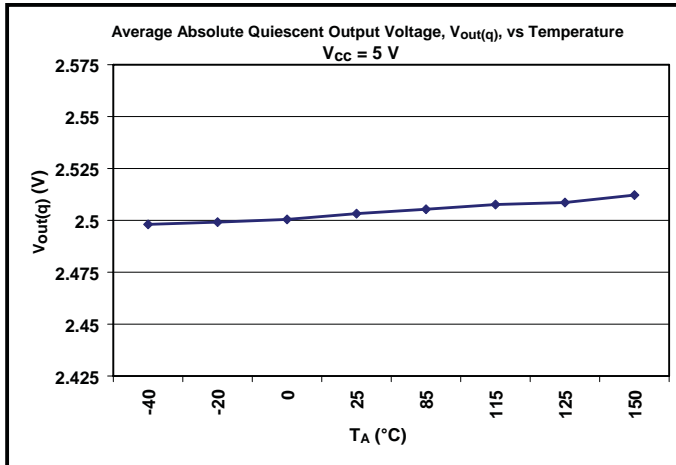
$$\text{Sym} = \frac{V_{\text{out}(+B)} - V_{\text{out}(q)}}{V_{\text{out}(q)} - V_{\text{out}(-B)}} \times 100\% \quad (8)$$

Typical Characteristics  
(30 pieces, 3 fabrication lots)



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Typical Characteristics, continued  
(30 pieces, 3 fabrication lots)

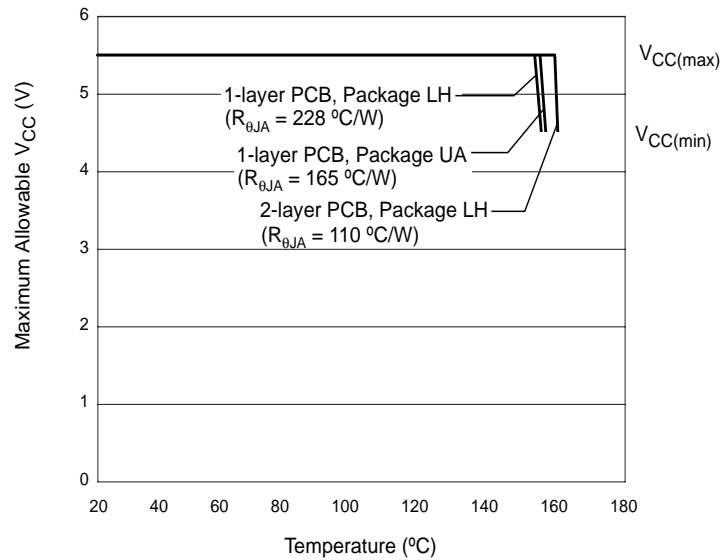


**THERMAL CHARACTERISTICS** may require derating at maximum conditions, see application information

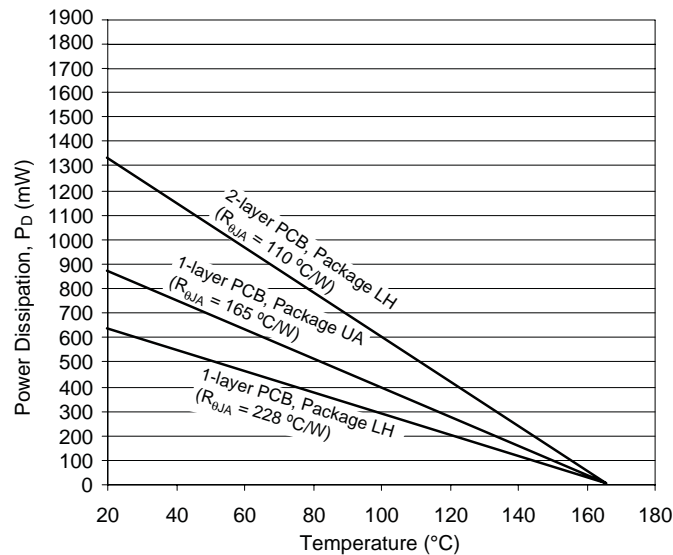
| Characteristic             | Symbol          | Test Conditions*   | Value | Units                       |
|----------------------------|-----------------|--|-------|-----------------------------|
| Package Thermal Resistance | $R_{\theta JA}$ | Package LH, 1-layer PCB with copper limited to solder pads   | 228   | $^{\circ}\text{C}/\text{W}$ |
|                            |                 | Package LH, 2-layer PCB with 0.463 in. <sup>2</sup> of copper area each side connected by thermal vias | 110   | $^{\circ}\text{C}/\text{W}$ |
|                            |                 | Package UA, 1-layer PCB with copper limited to solder pads   | 165   | $^{\circ}\text{C}/\text{W}$ |

\*Additional thermal information available on Allegro website.

**Power Derating Curve**



**Power Dissipation versus Ambient Temperature**





**Power Derating**

The device must be operated below the maximum junction temperature of the device,  $T_{J(max)}$ . Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating  $T_J$ . (Thermal data is also available on the Allegro MicroSystems Web site.)

The Package Thermal Resistance,  $R_{\theta JA}$ , is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity,  $K$ , of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case,  $R_{\theta JC}$ , is a relatively small component of  $R_{\theta JA}$ . Ambient air temperature,  $T_A$ , and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation,  $P_D$ ), can be estimated. The following formulas represent the fundamental relationships used to estimate  $T_J$ , at  $P_D$ .

$$P_D = V_{IN} \times I_{IN} \quad (1)$$

$$\Delta T = P_D \times R_{\theta JA} \quad (2)$$

$$T_J = T_A + \Delta T \quad (3)$$

For example, given common conditions such as:  $T_A = 25^\circ\text{C}$ ,  $V_{CC} = 12\text{ V}$ ,  $I_{CC} = 4\text{ mA}$ , and  $R_{\theta JA} = 140\text{ }^\circ\text{C/W}$ , then:

$$P_D = V_{CC} \times I_{CC} = 12\text{ V} \times 4\text{ mA} = 48\text{ mW}$$

$$\Delta T = P_D \times R_{\theta JA} = 48\text{ mW} \times 140\text{ }^\circ\text{C/W} = 7^\circ\text{C}$$

$$T_J = T_A + \Delta T = 25^\circ\text{C} + 7^\circ\text{C} = 32^\circ\text{C}$$

A worst-case estimate,  $P_{D(max)}$ , represents the maximum allowable power level ( $V_{CC(max)}$ ,  $I_{CC(max)}$ ), without exceeding  $T_{J(max)}$ , at a selected  $R_{\theta JA}$  and  $T_A$ .

*Example:* Reliability for  $V_{CC}$  at  $T_A = 150^\circ\text{C}$ , package UA, using minimum-K PCB.

Observe the worst-case ratings for the device, specifically:  $R_{\theta JA} = 165^\circ\text{C/W}$ ,  $T_{J(max)} = 165^\circ\text{C}$ ,  $V_{CC(max)} = 5.5\text{ V}$ , and  $I_{CC(max)} = 8\text{ mA}$ .

Calculate the maximum allowable power level,  $P_{D(max)}$ . First, invert equation 3:

$$\Delta T_{max} = T_{J(max)} - T_A = 165^\circ\text{C} - 150^\circ\text{C} = 15^\circ\text{C}$$

This provides the allowable increase to  $T_J$  resulting from internal power dissipation. Then, invert equation 2:

$$P_{D(max)} = \Delta T_{max} \div R_{\theta JA} = 15^\circ\text{C} \div 165\text{ }^\circ\text{C/W} = 91\text{ mW}$$

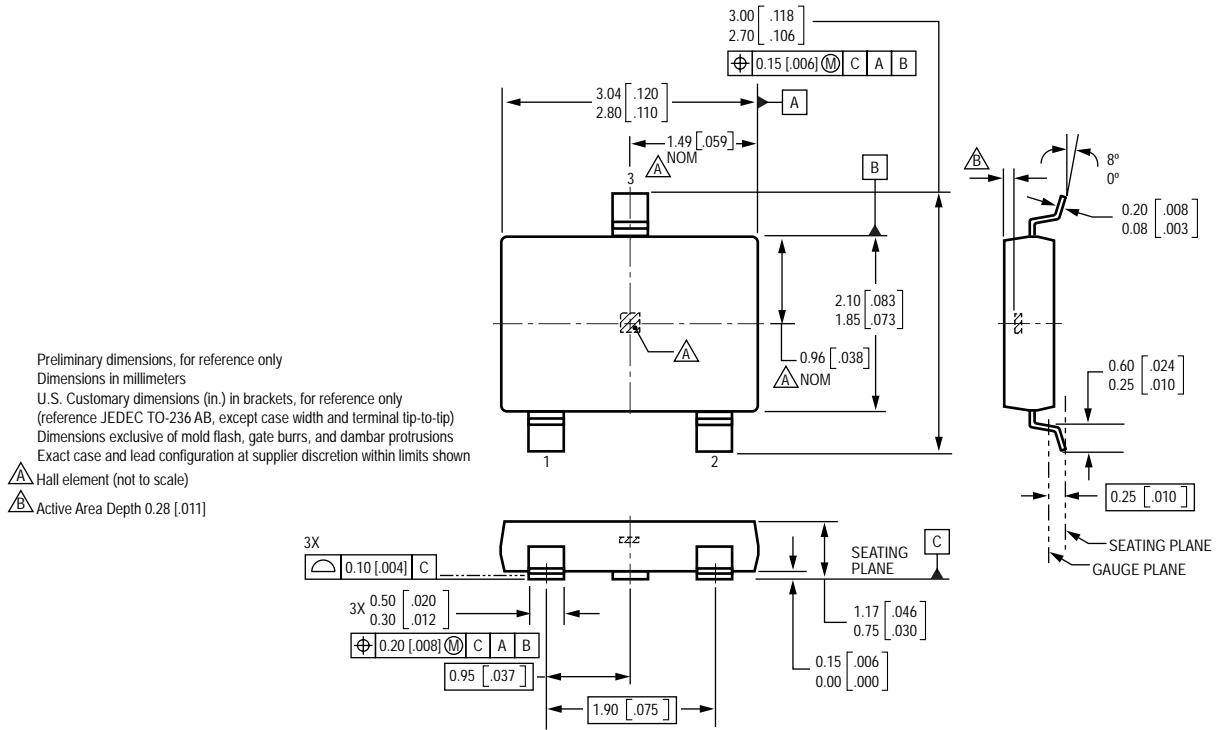
Finally, invert equation 1 with respect to voltage:

$$V_{CC(est)} = P_{D(max)} \div I_{CC(max)} = 91\text{ mW} \div 8\text{ mA} = 11.4\text{ V}$$

The result indicates that, at  $T_A$ , the application and device can dissipate adequate amounts of heat at voltages  $\leq V_{CC(est)}$ .

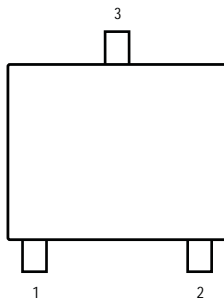
Compare  $V_{CC(est)}$  to  $V_{CC(max)}$ . If  $V_{CC(est)} \leq V_{CC(max)}$ , then reliable operation between  $V_{CC(est)}$  and  $V_{CC(max)}$  requires enhanced  $R_{\theta JA}$ . If  $V_{CC(est)} \geq V_{CC(max)}$ , then operation between  $V_{CC(est)}$  and  $V_{CC(max)}$  is reliable under these conditions.

**Package LH, 3-Pin; (SOT-23W)**

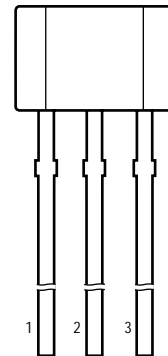


**Pin-out Drawings**

**Package LH**



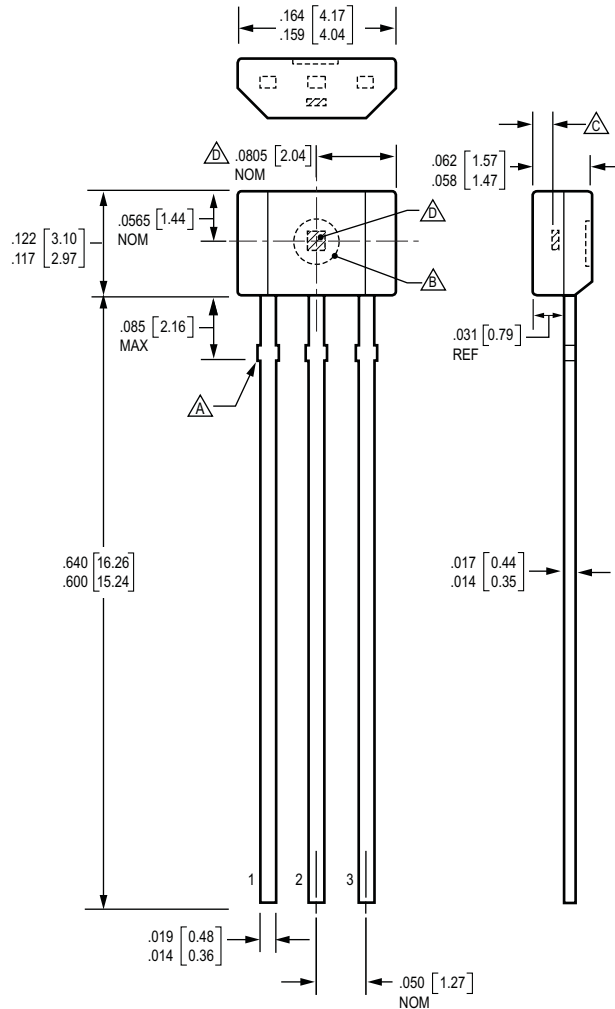
**Package UA**



**Terminal List**

| Symbol | Number     |            | Description                   |
|--------|------------|------------|-------------------------------|
|        | Package LH | Package UA |                               |
| VCC    | 1          | 1          | Connects power supply to chip |
| VOUT   | 2          | 3          | Output from circuit           |
| GND    | 3          | 2          | Ground                        |

**Package UA, 3-Pin SIP**



- Dimensions in inches  
Metric dimensions (mm) in brackets, for reference only
- Dambar removal protrusion (6X)
  - Ejector mark on opposite side
  - Active Area Depth .0195 [0.50] NOM
  - Hall element (not to scale)

The products described herein are manufactured under one or more of the following U.S. patents: 5,045,920; 5,264,783; 5,442,283; 5,389,889; 5,581,179; 5,517,112; 5,619,137; 5,621,319; 5,650,719; 5,686,894; 5,694,038; 5,729,130; 5,917,320; and other patents pending.

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